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IRLS640A

N-Channel Logic Level A-FET

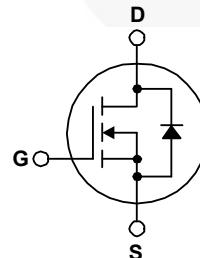
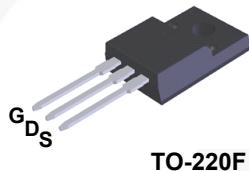
200 V, 9.8 A, 180 mΩ

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, DC-AC converters for uninterrupted power supply and motor control.

Features

- 9.8 A, 200 V, $R_{DS(on)} = 180 \text{ mΩ}$ @ $V_{GS} = 5 \text{ V}$
- Low Gate Charge (Typ. 40 nC)
- Low C_{rss} (Typ. 95 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- Logic-Level Gate Drive



Absolute Maximum Ratings

| Symbol | Characteristic | Value | Units |
|----------------|--|--------------|---------------------------|
| V_{DSS} | Drain-to-Source Voltage | 200 | V |
| I_D | Continuous Drain Current ($T_C=25^\circ\text{C}$) | 9.8 | A |
| | Continuous Drain Current ($T_C=100^\circ\text{C}$) | 6.2 | |
| I_{DM} | Drain Current-Pulsed | 63 | A |
| V_{GS} | Gate-to-Source Voltage | ± 20 | V |
| E_{AS} | Single Pulsed Avalanche Energy | 64 | mJ |
| I_{AR} | Avalanche Current | 18 | A |
| E_{AR} | Repetitive Avalanche Energy | 4.0 | mJ |
| dv/dt | Peak Diode Recovery dv/dt | 5 | V/ns |
| P_D | Total Power Dissipation ($T_C=25^\circ\text{C}$) | 40 | W |
| | Linear Derating Factor | 0.32 | $\text{W}/^\circ\text{C}$ |
| T_J, T_{STG} | Operating Junction and Storage Temperature Range | - 55 to +150 | $^\circ\text{C}$ |
| | Maximum Lead Temp. for Soldering Purposes, 1/8 " from case for 5-seconds | 300 | |

Thermal Resistance

| Symbol | Characteristic | Typ. | Max. | Units |
|-----------------|---------------------|------|------|---------------------------|
| $R_{\theta JC}$ | Junction-to-Case | -- | 3.13 | $^\circ\text{C}/\text{W}$ |
| | Junction-to-Ambient | -- | 62.5 | |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|----------|---------|----------------|-----------|------------|----------|
| IRLS640A | IRLS640A | TO-220F | Tube | N/A | N/A | 50 units |

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Characteristic | Min. | Typ. | Max. | Units | Test Condition |
|-----------------------------------|---|------|------|------|---------------|--|
| BV_{DSS} | Drain-Source Breakdown Voltage | 200 | -- | -- | V | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$ |
| $\Delta \text{BV}/\Delta T_J$ | Breakdown Voltage Temp. Coeff. | -- | 0.17 | -- | V/°C | $\text{I}_D=250\mu\text{A}$ See Fig 7 |
| $\text{V}_{\text{GS}(\text{th})}$ | Gate Threshold Voltage | 1.0 | -- | 2.0 | V | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$ |
| I_{GSS} | Gate-Source Leakage, Forward | -- | -- | 100 | nA | $\text{V}_{\text{GS}}=20\text{V}$ |
| | Gate-Source Leakage, Reverse | -- | -- | -100 | | $\text{V}_{\text{GS}}=-20\text{V}$ |
| I_{DSS} | Drain-to-Source Leakage Current | -- | -- | 10 | μA | $\text{V}_{\text{DS}}=200\text{V}$ |
| | | -- | -- | 100 | | $\text{V}_{\text{DS}}=160\text{V}, \text{T}_C=125^\circ\text{C}$ |
| $\text{R}_{\text{DS}(\text{on})}$ | Static Drain-Source On-State Resistance | -- | -- | 0.18 | Ω | $\text{V}_{\text{GS}}=5\text{V}, \text{I}_D=4.9\text{A}$ ④ |
| g_{fs} | Forward Transconductance | -- | 13.3 | -- | S | $\text{V}_{\text{DS}}=40\text{V}, \text{I}_D=4.9\text{A}$ ④ |
| C_{iss} | Input Capacitance | -- | 1310 | 1705 | pF | $\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, \text{f}=1\text{MHz}$ See Fig 5 |
| C_{oss} | Output Capacitance | -- | 200 | 250 | | |
| C_{rss} | Reverse Transfer Capacitance | -- | 95 | 120 | | |
| $\text{t}_{\text{d}(\text{on})}$ | Turn-On Delay Time | -- | 11 | 30 | | |
| t_r | Rise Time | -- | 8 | 25 | ns | $\text{V}_{\text{DD}}=100\text{V}, \text{I}_D=18\text{A}, \text{R}_G=4.6\Omega$ See Fig 13 ④ ⑤ |
| $\text{t}_{\text{d}(\text{off})}$ | Turn-Off Delay Time | -- | 46 | 100 | | |
| t_f | Fall Time | -- | 15 | 40 | | |
| Q_g | Total Gate Charge | -- | 40 | 56 | nC | $\text{V}_{\text{DS}}=160\text{V}, \text{V}_{\text{GS}}=5\text{V}, \text{I}_D=18\text{A}$ See Fig 6 & Fig 12 ④ ⑤ |
| Q_{gs} | Gate-Source Charge | -- | 6.8 | -- | | |
| Q_{gd} | Gate-Drain("Miller") Charge | -- | 18.6 | -- | | |

Source-Drain Diode Ratings and Characteristics

| Symbol | Characteristic | Min. | Typ. | Max. | Units | Test Condition |
|------------------------|---------------------------|------|------|------|---------------|---|
| I_s | Continuous Source Current | -- | -- | 18 | A | Integral reverse pn-diode in the MOSFET |
| I_{SM} | Pulsed-Source Current ① | -- | -- | 63 | | |
| V_{SD} | Diode Forward Voltage ④ | -- | -- | 1.5 | V | $\text{T}_J=25^\circ\text{C}, \text{I}_s=9.8\text{A}, \text{V}_{\text{GS}}=0\text{V}$ |
| t_{rr} | Reverse Recovery Time | -- | 224 | -- | ns | $\text{T}_J=25^\circ\text{C}, \text{I}_F=18\text{A}$ |
| Q_{rr} | Reverse Recovery Charge | -- | 1.55 | -- | μC | $d\text{I}/dt=100\text{A}/\mu\text{s}$ ④ |

Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=1\text{mH}, \text{I}_{\text{AS}}=9.8\text{A}, \text{V}_{\text{DD}}=50\text{V}, \text{R}_G=27\Omega$, Starting $\text{T}_J=25^\circ\text{C}$
- ③ $\text{I}_{\text{SD}} \leq 18\text{A}, d\text{I}/dt \leq 260\text{A}/\mu\text{s}, \text{V}_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, Starting $\text{T}_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = $250\mu\text{s}$, Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

Typical Characteristics

Fig 1. Output Characteristics

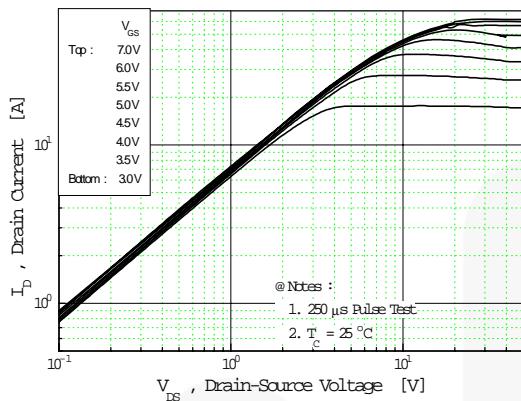


Fig 2. Transfer Characteristics

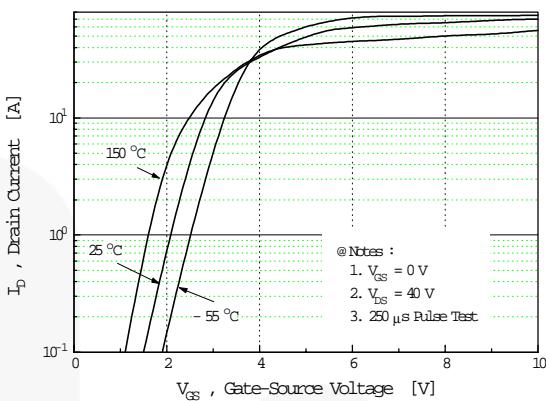


Fig 3. On-Resistance vs. Drain Current

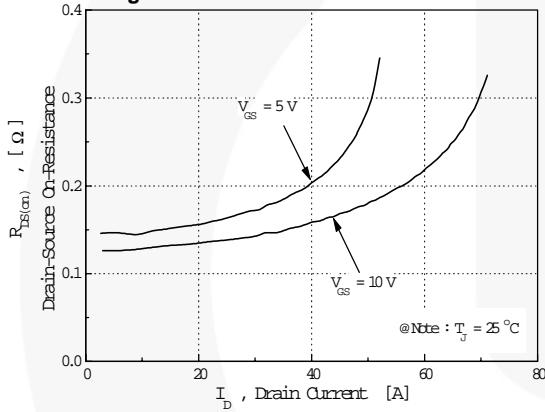


Fig 4. Source-Drain Diode Forward Voltage

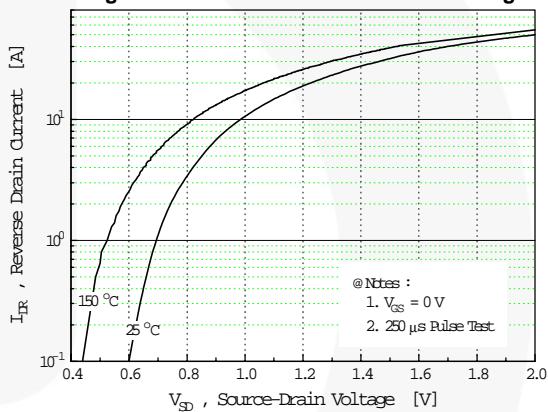


Fig 5. Capacitance vs. Drain-Source Voltage

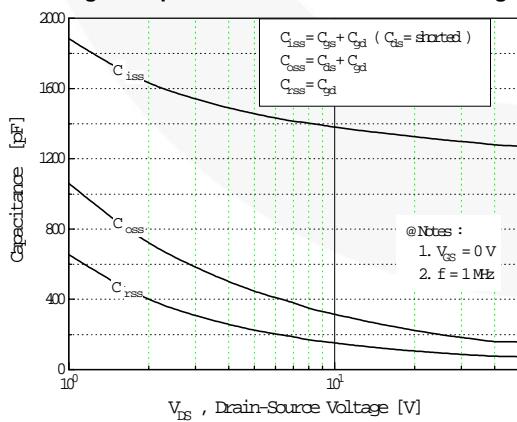
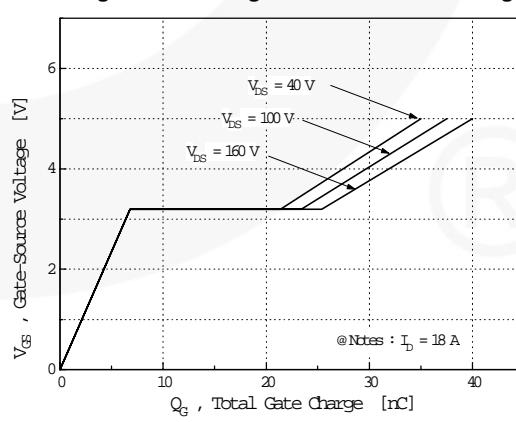


Fig 6. Gate Charge vs. Gate-Source Voltage



Typical Characteristics (continued)

Fig 7. Breakdown Voltage vs. Temperature

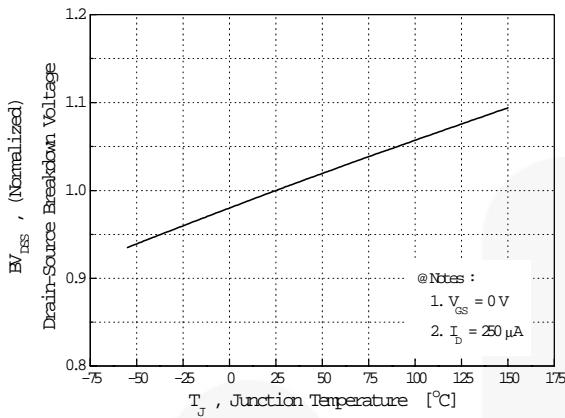


Fig 8. On-Resistance vs. Temperature

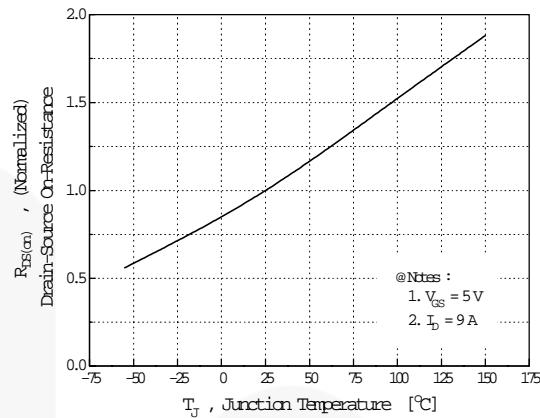


Fig 9. Max. Safe Operating Area

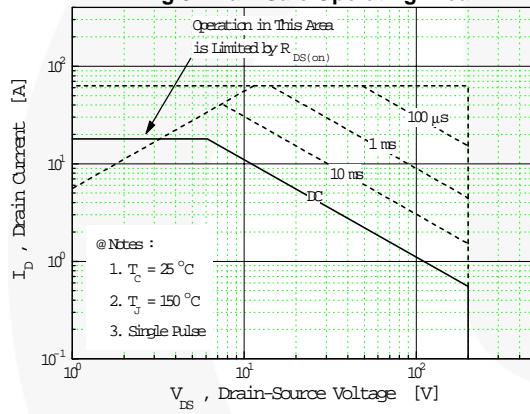


Fig 10. Max. Drain Current vs. Case Temperature

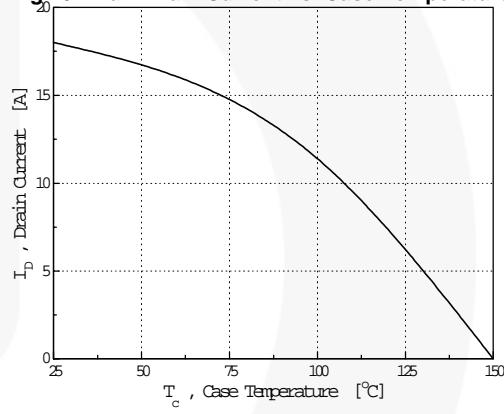
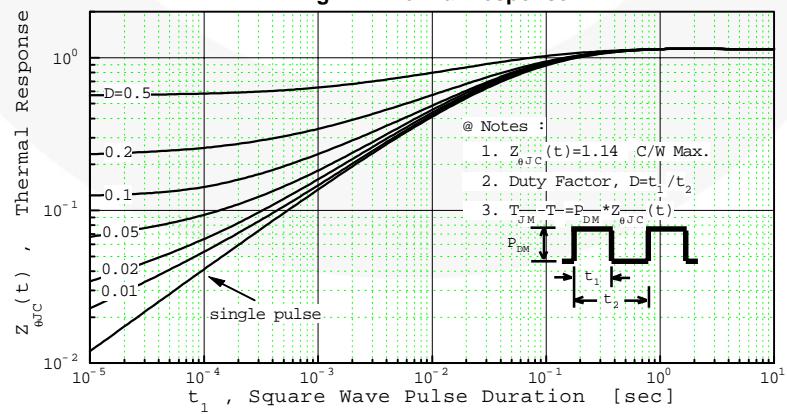


Fig 11. Thermal Response



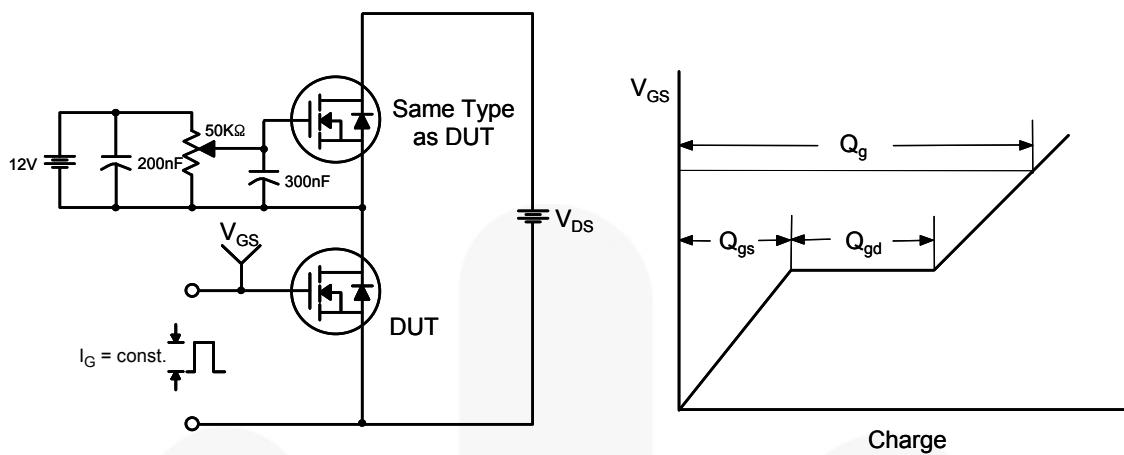


Figure 12. Gate Charge Test Circuit & Waveform

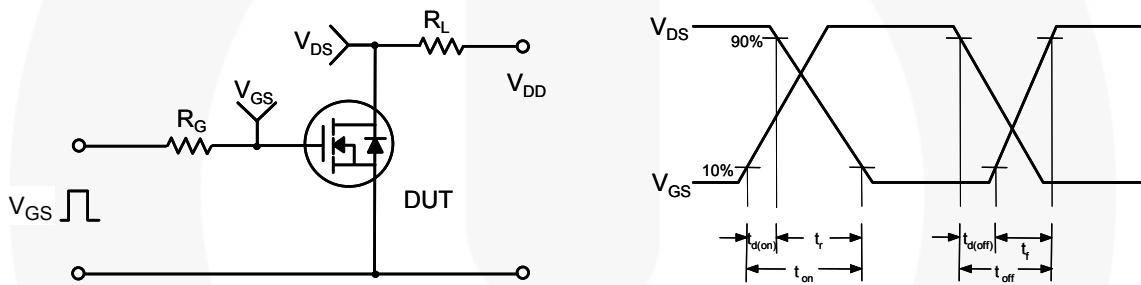


Figure 13. Resistive Switching Test Circuit & Waveforms

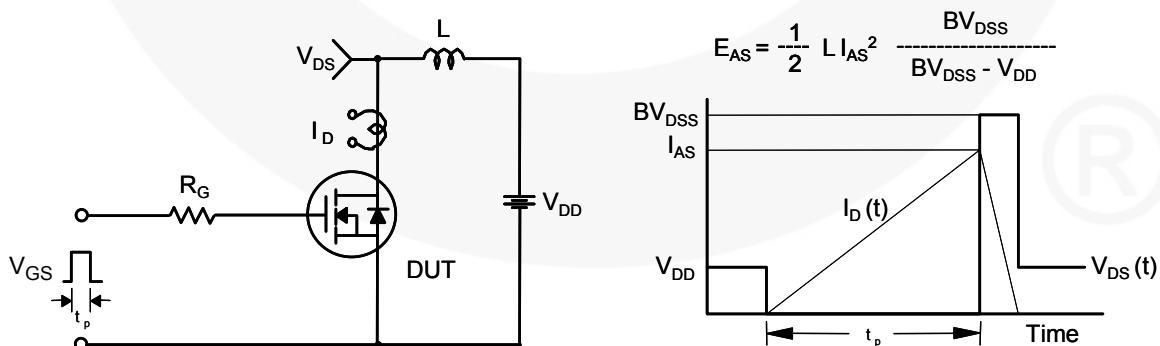


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

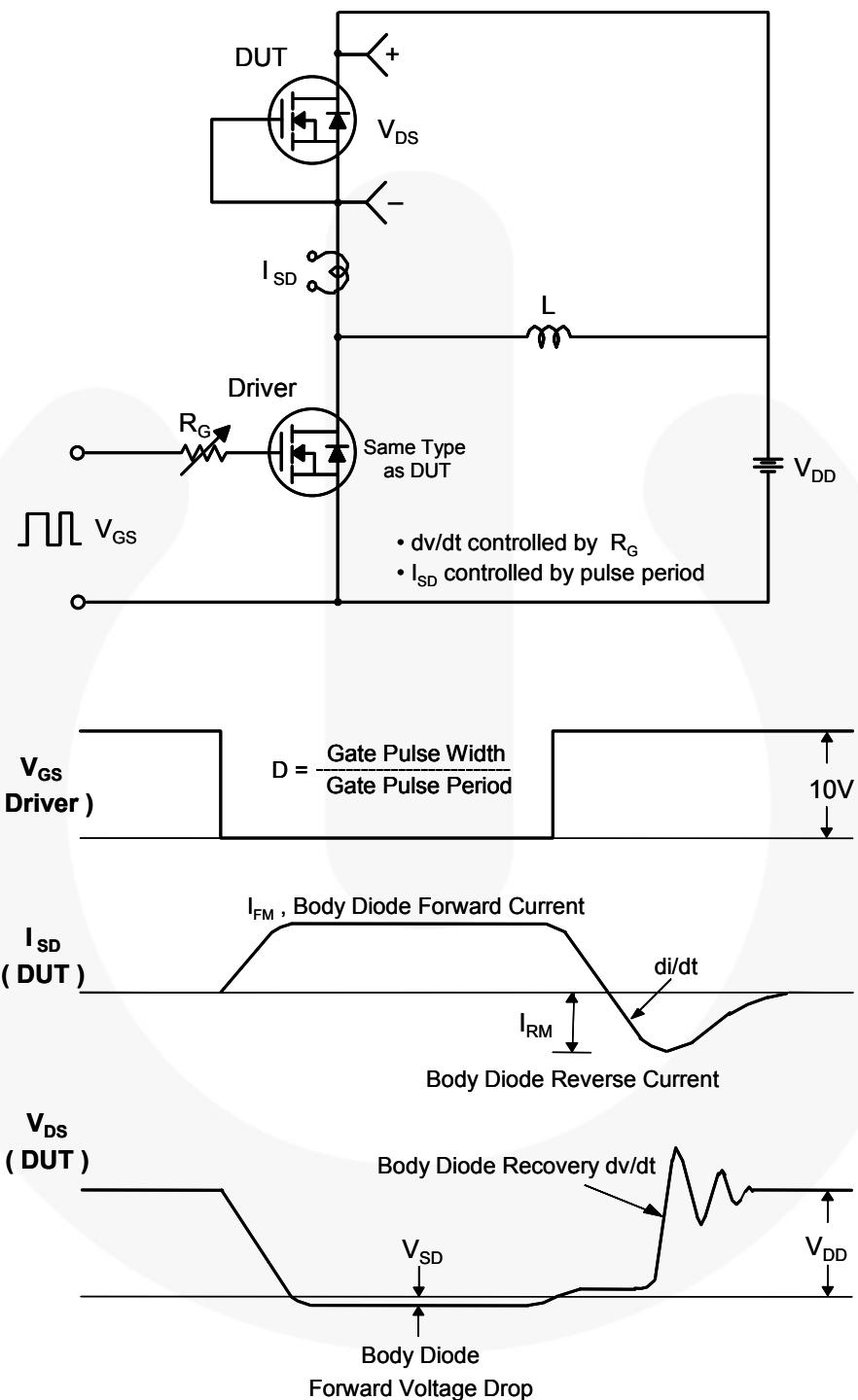


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

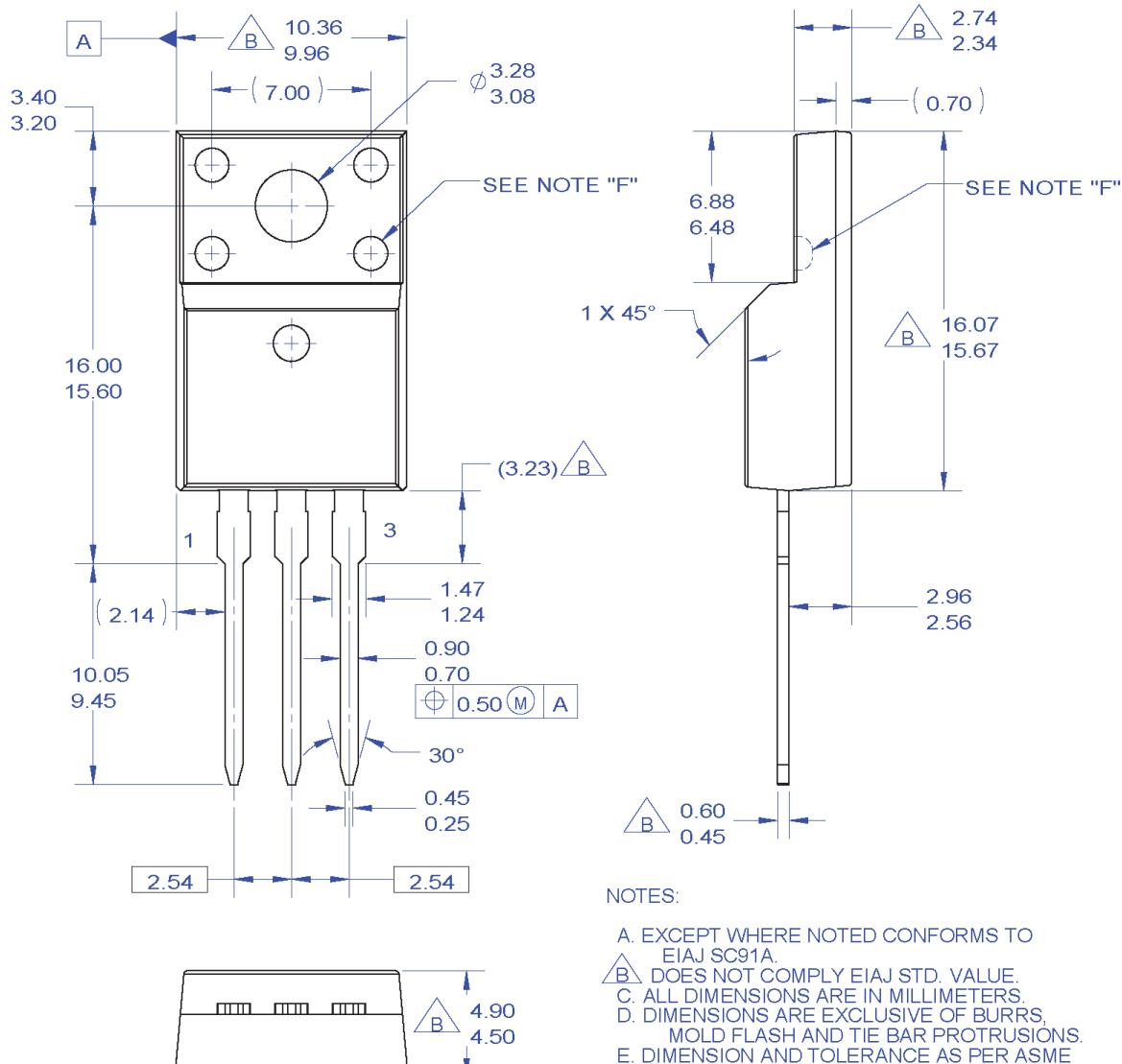


Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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